SPECIFICATIONS							
CUSTOMER	:						
SAMPLE CODE	: SH128800T002-ZBC01						
MASS PRODUCTION CODE	PH128800T002-ZBC01						
SAMPLE VERSION	. 02						
SPECIFICATIONS EDITION	. 007						
DRAWING NO. (Ver.)	LMD-PH128800T002-ZBC01 (Ver.003)						
PACKAGING NO. (Ver.)	PKG-PH128800T002-ZBC01 (Ver.003)						

Customer Approved

Date:

Approved	Checked	Designer
黃秋源	石建 莊	黄俊清
Oliver Huang	Stone Shin	Ackey Huang

☐ Preliminary specification for design input

Specification for sample approval

2018.12.05 TW RD APR

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
03/14/2016	01	001	New Drawing.	-	Ackey
06/08/2016	01	002	New Sample.	-	Ackey
06/30/2016	01	003	Modify 1.1 Features & 3.2 Inspection Specification & 4.1 Reliability Test Condition content.		Ackey
02/09/2017	02	004	Second Sample. (Change CTP IC->Atmel IC) & Change Tray Package Number.	10, Appendix	Ackey
08/24/2017	02	005	Modify Drawing.	Appendix	Ackey
08/31/2018	02	006	Modify Packaging	Appendix	Ackey
12/05/2018	02	007	Modify DC Electrical Characteristics (Digital Supply Voltage 3.3V→2.5V).	6	Ackey
		1			

Total: 28 Page



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- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix : LCM Drawing.

LCM Packaging Specifications.



1. SPECIFICATIONS

1.1 Features

i i catares			
Item	Standard Value		
Screen size(inch)	10.1(Diagonal)		
Driver element	IPS		
Resolution	1280* (R · G · B) * 800 Dots		
Display mode	Normally Black, Transmissive		
Touch panel	Projective Capacitive Touch Panel		
Touch panel	5 Points touch		
Surface treatment	Anti-Fingerprint Coating		
Color arrangement	RGB-stripe		
Weight	292.74(Typ.)		
inversion	1+2line		
Interface	LVDS		
IC	HX8288*4 & HX8695*1		
	THIS PRODUCT CONFORMS THE ROHS OF PTC		
ROHS	Detail information please refer website:		
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1		

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	254.96(W) * 173.6 (L) * 7.4 (H)	mm

LCD panel

Item	Standard Value			
Active Area	216.96 (W) * 135.60 (L)	mm		

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Digital Supply Voltage	VDD	-	-0.3	+3.9	V
TFT Gate on voltage	VGH	-	-0.3	+42	V
TFT Gate off voltage	VGL	-	-19	+0.3	V
TFT Gate voltage	VGH-VGL	-	+12	+40	
Analog power supply voltage	AVDD	-	-0.3	+14	V
Operating Temperature	T _{OP}	-	-20	+70	$^{\circ}\mathbb{C}$
Storage Temperature	T _{ST}	-	-30	+80	$^{\circ}\!\mathbb{C}$
Storage Humidity	H _D	Ta<60 °C	20	90	%RH

Note 1: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.





1.4 DC Electrical Characteristics

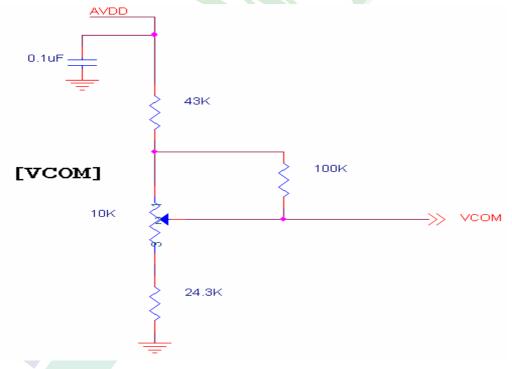
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Digital Supply Voltage	VDD	-	2.3	2.5	2.7	
Analog power supply voltage	AVDD	-	8.0	8.2	8.4	V
TFT Gate on voltage	VGH	-	21.7	22.0	22.3	V
TFT Gate off voltage	VGL	-	-7.3	-7.0	-6.7	V
TFT Common electrode voltage	VCOM	1	2.7	3.0	3.3	٧
Input logic high voltage	VIH	-	0.8*VDD	-	VDD	V
Input logic low voltage	VIL	-	0	-	0.2*VDD	٧
		VDD=2.5V			<i></i>	
Supply Current	IDD	Pattern=) -	100	150	mA
		Picture*4				

Note 1: Be sure to apply VDD and VGL to the LCD first, and then apply VGH.

Note 2: VDD setting should match the signals output voltage (VIH / VIL) of customer's system board.

Note 3: Typical VCOM is only a reference value, it must be optimized according to each LCM. Be sure to use VR.

Note 4: Maximum current display.





1.5 Optical Characteristics

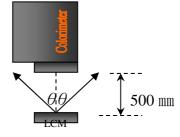
TFT LCD Panel Ta=25 ℃

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	-
Response time		Tr		-	10	20	ms	Note2
riesponse iii	i c	Tf	-	-	15	30	1115	Notez
	Тор	ΘΥ+		75	85	-		
Viouing angle	Bottom	ΘΥ-	CR ≥ 10	75	85	-	Dog	Note4
Viewing angle	Left	ΘХ-	ΘX- CR ≥ 10 75 85	-	Deg.	Note4		
	Right	ΘХ+		75	85	-		
Contrast rati	0	CR		600	800	-	-	Note3
Color of CIE		Х	IF=240mA	0.26	0.31	0.36		
Coordinate	White		11 –24011/1					Note1
(With B/L)		Υ		0.31	0.36	0.41		
Average Bright Pattern=white di		IV	IF=240mA	450	500	>	cd/m2	Note1
Luminance unifo	ormity	YU	IF=240mA	75	80	-	%	Note1

Note1:

- $1 : \triangle B=B(min) / B(max) \times 100\%$
- 2 : Measurement Condition for Optical Characteristics:
 - a: Environment: 25° C $\pm 5^{\circ}$ C / $60\pm 20\%$ R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: 500 \pm 50 mm \rightarrow (θ = 0°)
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





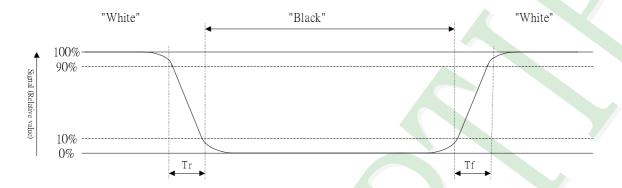
Colorimeter=BM-7 fast



Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

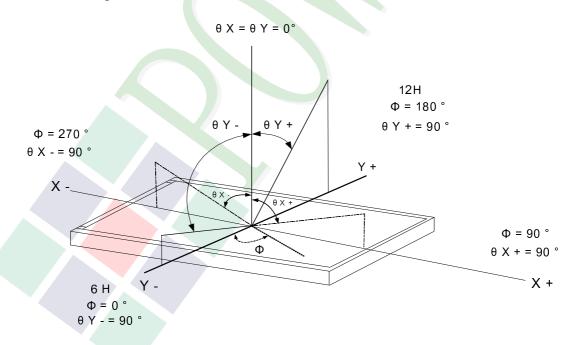
Contrast ratio is calculated with the following formula

Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle: Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Power Dissipation	Pd	-	-	4680	-	mW
LED Forward Current	IF	1 LED	-	-	70	mA
LED Reverse Voltage	VR	1 LED	-	-	5	V

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Voltage for LED backlight	VF		16.8	(19.5)	21	V
Current for LED backlight	IF		200	240	280	mA
Color			White			

Other Description

Item	Conditions	Description
Life Time	Ta =25°C IF= 200mA	20000 hrs

Note: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IF =200mA. The LED lifetime could be decreased if operating IF is larger than 200mA.



1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	10.1
Touch type	Projective capacitive touch panel
Input Method	Finger / 5 Points touch
Output Interface	USB
Response Time	≦25ms
Light Transparency	85% Min
Surface Hardness	7H(Pencil)

Mechanical Specifications

Item	Standard Value	Unit
Viewing Area	217.96 (W) * 136.6 (L)	mm

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	TPVDD	-	-0.3	+6.0	٧
Operating Temperature	Тор	-	-20	+70	ç
Storage Temperature	T _{ST}	-	-30	+80	°C

DC Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	TPVDD	-	-	5.0	-	V

Touch Panel IC Read/Write description & Register Mapping

Reference: Atmel Touch Driver Porting Reference Guide.



Interface Pin Description

CN2

Pin No.	Symbol	Function
1	TPVDD	Digital I/O Power Can be Set as TPVDD.
2	USB-D-	USB Differential Signal D
3	USB-D+	USB Differential Signal D+.
4	NC	Not Connection.
5	GND	Ground.
6	NC	Not Connection.



2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram





2.2 Interface Pin Description

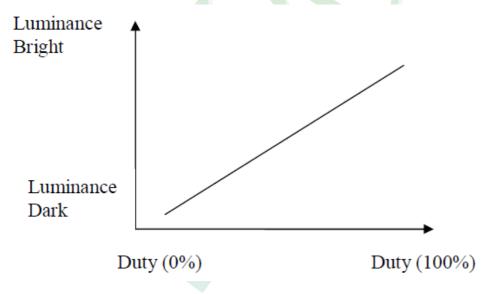
A 40pin connector is used for the module electronics interface. The recommended model is FH52-40S-0.5SH manufactured by Vigor Conn.

Pin No.	Symbol	Description
1	VCOM	Common voltage
2	VDD	Digital power
3	VDD	Digital power
4	NC	Not connect
5	NC	Not connect
6	NC	Not connect
7	GND	Ground
8	RXIN0-	Negative LVDS differential data inputs
9	RXIN0+	Positive LVDS differential data inputs
10	GND	Ground
11	RXIN1-	Negative LVDS differential data inputs
12	RXIN1+	Positive LVDS differential data inputs
13	GND	Ground
14	RXIN2-	Negative LVDS differential data inputs
15	RXIN2+	Positive LVDS differential data inputs
16	GND	Ground
17	RXCLKIN-	Negative LVDS differential clock inputs
18	RXCLKIN+	Positive LVDS differential clock inputs
19	GND	Ground
20	RXIN3-	Negative LVDS differential data inputs
21	RXIN3+	Positive LVDS differential data inputs
22	GND	Ground
23	NC	Not connect
24	NC	Not connect
25	GND	Ground



Pin No.	Symbol	Description
26	NC	Not connect
27	LED_PWM	CABC controller signal output for backlight
28	NC	Not connect
29	AVDD	Power for Analog Circuit
30	GND	Ground
31	LED-	LED Cathode
32	LED-	LED Cathode
33	NC	Not connect
34	NC	Not connect
35	VGL	Gate OFF Voltage
36	GND	Ground
37	CABC_EN	CABC Enable Input. High Voltage: Enable; Low Voltage or open: Disable
38	VGH	Gate ON Voltage
39	LED+	LED Anode
40	LED+	LED Anode

Note: LED_PWM is used to adjust backlight brightness

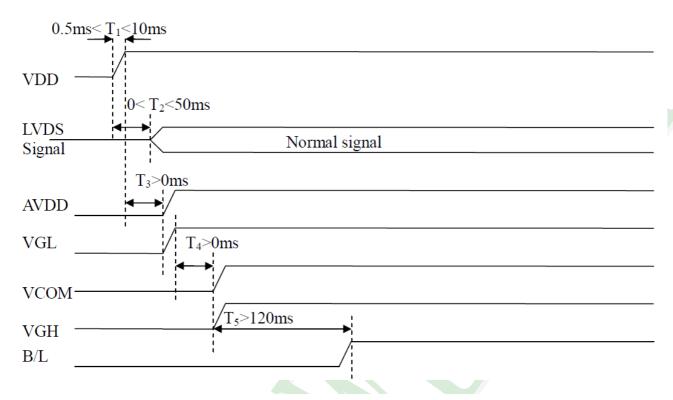




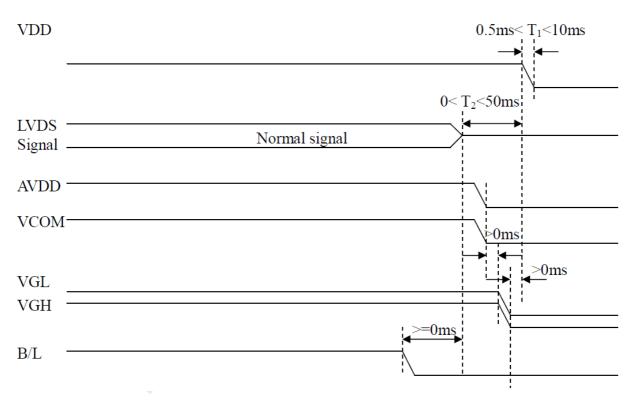
2.3 Timing Characteristics

2.3.1 POWER ON/OFF SEQUENCE

a. Power on:



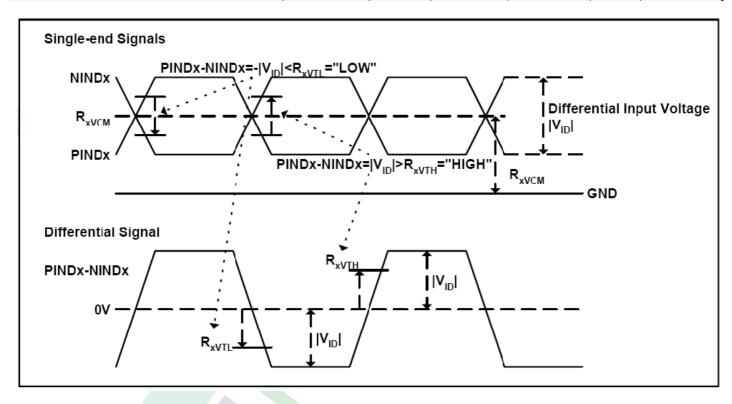
b. Power off:





2.3.2 LVDS Signal Timing Characteristics AC Electrical Characteristics

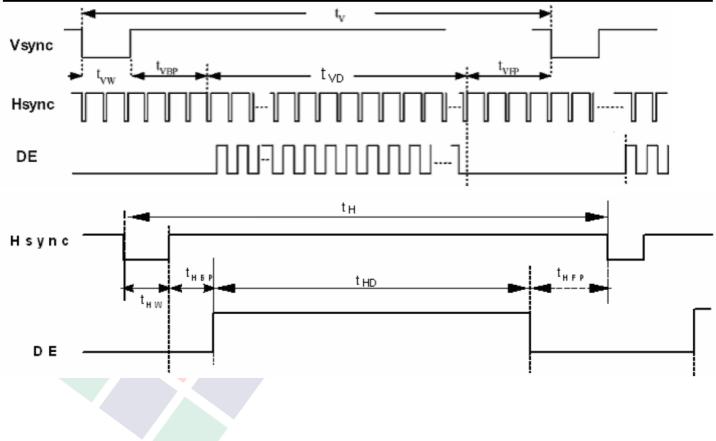
Parameter	Symbol	Values			Unit	Remark
	, , , , , , , , , , , , , , , , , , , ,	Min.	Typ.	Max.		
LVDS Differential input high Threshold voltage	R _{xVTH}	-	-	+100	mV	R _{XVCM} =1.2
LVDS Differential input low Threshold voltage	R _{xVTL}	-100	-	-	mV	V
LVDS Differential input common mode voltage	R _{xVCM}	0.7	-	1.6	V	
LVDS Differential voltage	V _{ID}	200	-	600	mV	





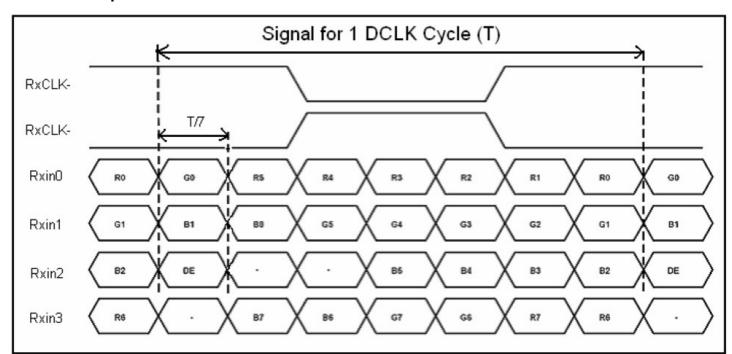
Timing Table

ltem	Sumbol	Values			Unit	Remark
item	Symbol	Min.	Тур.	Max.	Onit	Remark
Clock Frequency	1/Tc	68.9	71.1	73.4	MHz	Frame rate =60Hz
Horizontal display area	tHD		1280		Тс	
HS period time	tн	1410	1440	1470	Тс	
HS Width +Back Porch +Front Porch	thw+ thbp +thfp	130	160	190	Тс	
Vertical display area	tvo		800		tн	
VS period time	tv	815	823	833	tн	
VS Width +Back Porch +Front Porch	tvw+ tvBP +tvFP	15	23	33	tн	





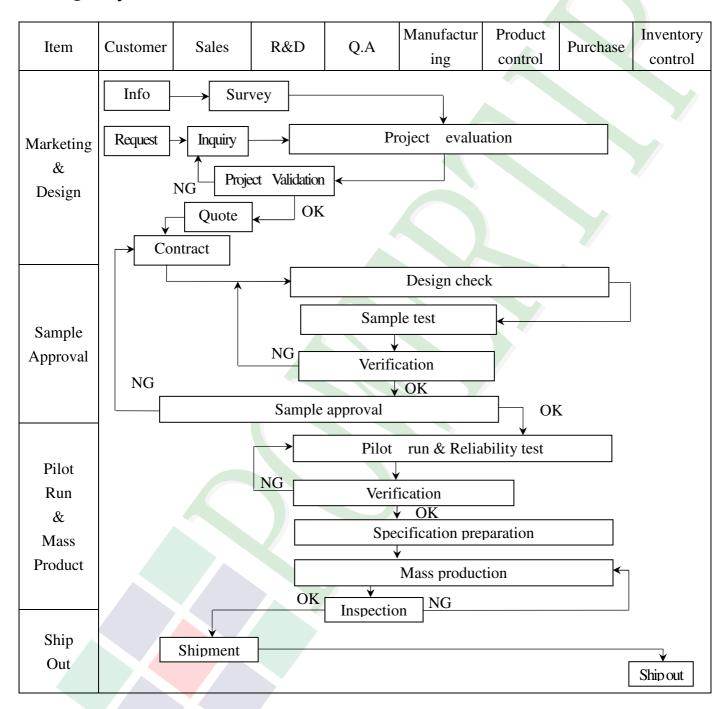
LVDS Data Input Format



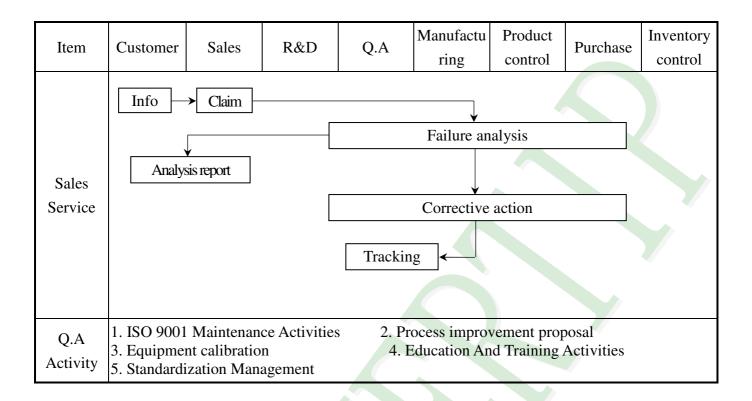


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3, 5" ~10" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment: Gauge · MIL-STD · Powertip Tester · Sample

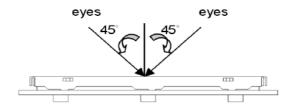
◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5

♦OUT Going Defect Level: Sampling.

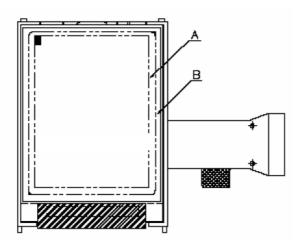
◆Standard of the product appearance test:

a. Manner of appearance test:

- (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)

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◆Specification For TFT-LCD Module 3. 5" ~10":

NO	Item		Criterion					
		1	part nui	nber is inconsistent	with work order of		Major	
01	Product condition	1. 2 Mix	ed prod	uct types.			Major	
		1. 3 Asse	mbled i	n inverse direction.			Major	
02	Quantity	2. 1The	quantity	is inconsistent with	work order of production	on.	Major	
03	Outline dimension		3. 1 Product dimension and structure must conform to structur diagram.					
		4. 1 Miss	sing line	character and icon.	•		Major	
		4. 2 No f	4. 2 No function or no display.					
04	Electrical Testing	4. 3 Display malfunction.					Major	
		4. 4 LCD viewing angle defect.						
		4. 5 Cur	rent con	sumption exceeds p	roduct specifications.		Major	
		Г		-	(01)			
				Item	Acceptance (Q'ty)			
	Dot defect		-	Bright Dot	≦ 4			
			Dot	Dark Dot	≦ 5			
٥٦	(Bright dot >		Defect	Joint Dot	≦ 3		3.5	
05	Dark dot)			Total	≦ 7		Minor	
	On -display	5. 1 Inspection pattern: full white, full black, Red, Green and						
				blue screen	s.			
		5. 2 It is	defined	as dot defect if defe	ect area $>1/2$ dot.			
		5. 3 The	distanc	e between two dot d	efect ≥ 5 mm.			



igspace Specification For TFT-LCD Module 3. 5" ~10":

NO	Item		Criterion						
			6. 1 Round type (Non-display or display) :						
			Dimonsion	ı (diameter : Ф	Ac	ceptance ((Q'ty)		
			Dimension	(mameter · Ф	A aı	rea	B area		
	Black or white dot \ scratch \			$\Phi \leq 0.25$	Igne	ore			
	contamination		0.25 <	$<\Phi \le 0.50$	5				
	Round type			$\Phi > 0.50$	0		Ignore		
	$X \leftarrow Y$,	Total	5				
06	$\Phi = (x+y)/2$	6. 2 Lin	ne type(N	on-display or d	isplay) :			Minor	
	Line type	_ (= , , , , , =				***	Acceptance (Q't		
		Line type Length (I	ength (L)) Width (W)		A area	B area		
				W	≤ 0.03	Ignore	;		
		L	. ≤10.0	0.03 < W	≤ 0.05	4			
		I	L ≦5.0	0.05 < W	≤ 0.10	2	Ignore		
				W	>0.10	As roun type	d		
				Total		5			
					Ac	ceptance	(O'ty)		
		Dir	mension (liameter : Φ)	A ar		B area		
				$\Phi \leq 0.25$	Igno	ore			
07	Polarizer		0.25 <	$\Phi \leq 0.50$	4			Minor	
	Bubble		0.50 <	$\Phi \le 0.80$	1		Ignore		
				$\Phi > 0.80$	0				
			To	otal	5				



◆Specification For TFT-LCD Module 3. 5″ ~10″:

NO	Item		Criterion		Level
08	The crack of glass	Z: The the the term of the term of the the term of the	ngth of crack ickness of crack ickness of glass al glass chip: ip on panel surface and cra	Z Y SP [NG]	Minor
		X	Y	Z	
		≦ a	Crack can't enter viewing area	≦1/2 t	
		$\leq a$	Crack can't exceed the half of SP width.	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	



igspace Specification For TFT-LCD Module 3. 5" ~10":

NO	Item	Criterion			Level
	The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1. 2 Corner crack:			
		X	Y	Z	
		≤1/5 a	Crack can't enter viewing area	$\mathbf{Z} \leq 1/2 \mathbf{t}$	
		≤1/5 a	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$	
08		8.2 Protrusion over terminal: 8.2.1 Chip on electrode pad:			Minor
		W Y X X Y Z			
			X	$\frac{\mathbf{x}}{\mathbf{x}}$	
		Front		$\leq 1/2 \mathrm{W} \qquad \leq t$	
		Back	≦ a ≤	\leq W \leq 1/2 t	



♦ Specification For TFT-LCD Module 3. 5'' ~10'':



4. RELIABILITY TEST

4.1 Reliability Test Condition

	4.1 Reliability lest Colluition				
NO.	TEST ITEM	TEST CONDITION			
1	High Temperature Storage Test	Keep in +80 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.			
2	Low Temperature Storage Test	Keep in −30 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.			
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)			
4	Temperature Cycling Storage Test	$-30^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ $(30\text{mins}) (5\text{mins}) (5\text{mins})$ $\downarrow \qquad \qquad$			
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: 15° C $\sim 35^{\circ}$ C 2. Humidity relative: $30\% \sim 60\%$ 3. Energy Storage Capacitance(Cs+Cd): $150\text{pF}\pm10\%$ 4. Discharge Resistance(Rd): $330\Omega\pm10\%$ 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: $\pm 5\%$)			
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min) The amplitude of vibration :1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs 			
7	Drop Test (Packaged)	Packing Weight (Kg) 0 ~ 45. 4 122 45. 4 ~ 90. 8 76 90. 8 ~ 454 61 Over 454 46 Drop direction: **1 corner / 3 edges / 6 sides each 1 times			



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

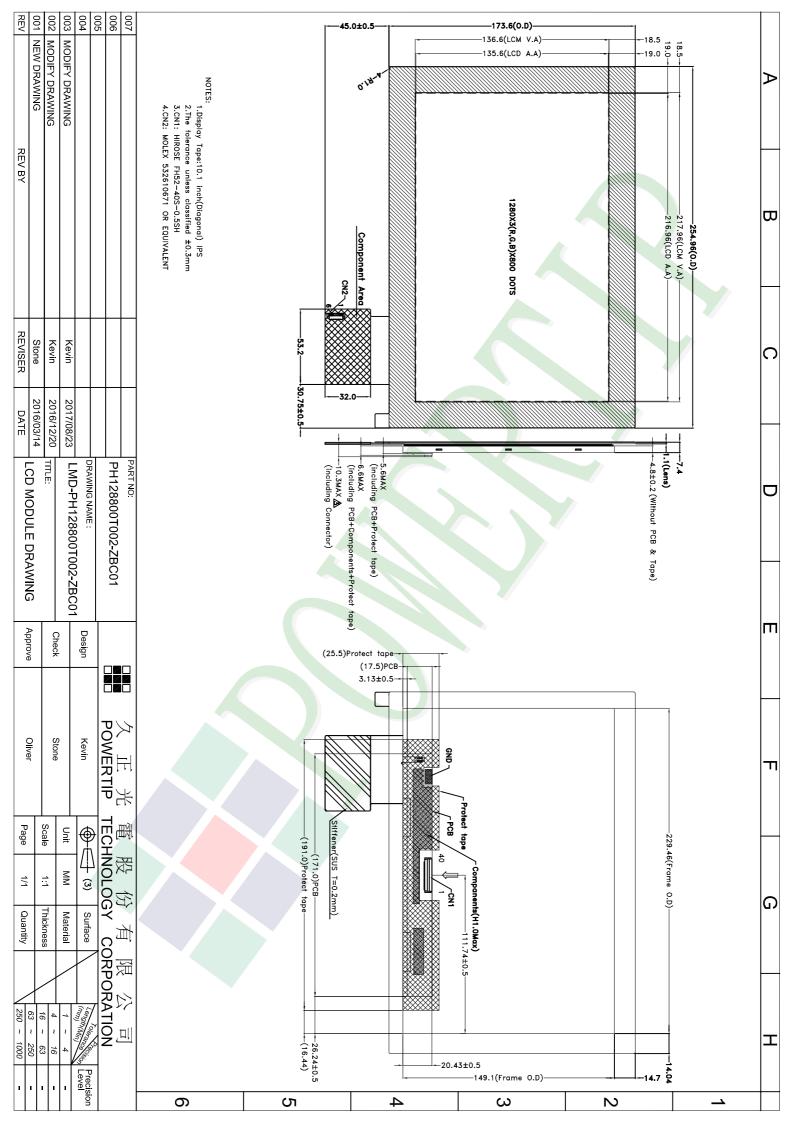
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
 - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact LCM包裝規格書 Ver.003 LCM Packaging Specifications Documents NO. PKG-PH128800T002-ZBC01 Oliver Stone Kevin (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Quantity Total Weight 1 成品 (LCM) PH128800T002-ZBC01 254.96 X 173.6 0.4735 18 8.523 2 多層薄膜(1)POF OTFILM0BA03ABA 3 3 TRAY 盤 (2)Tray TY00000000394 517 X 377 X 18.8 0.2 12 2.4 4 内盒(3)Product Box 3 BX00000000071 558 X 393 X 68 0.6 1.8 5 保利龍板(4)Polylon board OTPLB00PL08ABA 550 X 393 X 20 0.0284 2 0.0568 外紙箱(5)Carton 6 BX57041027CCBA 570 X 410 X 265 1.4208 1 1.4208 7 EPE(6)EPE OTFOAMEP0003BA 333 X 218 X 10 0.022 0.066 3 8 9 2. 整箱總重量 (Total LCD Weight in carton): 14.26 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCD quantity per box : no per tray x no of tray 2 3 6 (2)Total LCD quantity in carton: quantity per box x no of boxes 6 3 18 Use empty tray 空盤 (4)保利龍板 Polylon board (1)多層薄膜 POF (2)TRAY 盤 Put products into the tray Tray (6)EPE (5)外紙箱 Carton Tray stacking (3)内盒 Product Box 特 記 事 項 (REMARK) 5.OTFOAMEP0003BA可裁: 6.需裝外箱出貨,數量不足時,用內盒 斜角 Detail B 尺寸 333.0 X 54.5mm => 4 PCS 空箱填滿外箱空隙 4. TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.